

Electronic Patent Application Fee Transmittal

Application Number:	10594907
Filing Date:	07-Aug-2008
Title of Invention:	LASER PROCESSING METHOD FOR CUTTING SUBSTRATE AND LAMINATE PART BONDED TO THE SUBSTRATE
First Named Inventor/Applicant Name:	Takeshi Sakamoto
Filer:	Nikolaus P. Schibli/Margit Phillips
Attorney Docket Number:	46884-5519 (232060)

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180